

STGF7NB60SL

N-CHANNEL 7A - 600V - TO-220FP PowerMESH™ IGBT

Table 1: General Features

TYPE	V _{CES}	V _{CE(sat)} (Max) @25°C	lc @100°C
STGF7NB60SL	600 V	< 1.6 V	7 A

- POLYSILICON GATE VOLTAGE DRIVEN
- LOW THRESHOLD VOLTAGE
- LOW ON-VOLTAGE DROP
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY

DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH[™] IGBTs, with outstanding performances. The suffix "S" identifies a family optimized achieve minimum on-voltage drop for low frequency applications (<1kHz).

APPLICATIONS

- LIGHT DIMMER
- STATIC RELAYS

Figure 1: Package

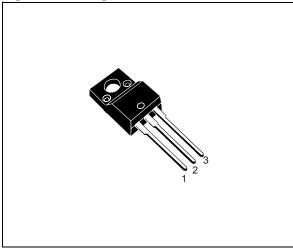


Figure 2: Internal Schematic Diagram

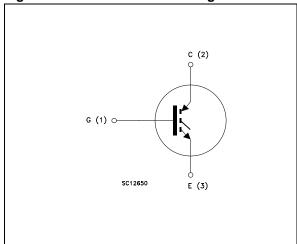


Table 2: Order Codes

SALES TYPE	MARKING	PACKAGE	PACKAGING	
STGF7NB60SL	STGF7NB60SL GF7NB60SL		TUBE	

September 2004

Table 3: Absolute Maximum ratings

Symbol	Parameter	Value	Symbol	
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V	
V _{ECR}	Reverse Battery Protection	20	V	
V _{GE}	Gate-Emitter Voltage	± 20	V	
I _C Collector Current (continuous) at 25°C		15	A	
I _C Collector Current (continuous) at 100°C		7	A	
I _{CM} (1)	Collector Current (pulsed)	20	Α	
Ртот	Total Dissipation at T _C = 25°C	25	W	
	Derating Factor	0.2	W/°C	
V _{ISO}	Insulation Withstand Voltage A.C.	2500	V	
T _{stg}	Storage Temperature		°C	
Tj	Operating Junction Temperature	- 55 to 150 °C		

⁽¹⁾Pulse width limited by max. junction temperature.

Table 4: Thermal Data

Rthj-case	Thermal Resistance Junction-case Max	5	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_{CASE} =25°C UNLESS OTHERWISE SPECIFIED)

Table 5: Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR} (CES)	Collectro-Emitter Breakdown Voltage	$I_C = 250 \mu A, V_{GE} = 0$	600			V
V _{BR(ECS)}	Emitter-Collector Breakdown Voltage	$I_C = 1$ mA, $V_{GE} = 0$	20			V
I _{CES}	Collector-Emitter Leakage Current (V _{CE} = 0)	V _{GE} = Max Rating Tc=25°C Tc=125°C			10 100	μA μA
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	V _{GE} = ± 20 V , V _{CE} = 0			±100	nA

Table 6: On

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE}=V_{GE}$, $I_{C}=250 \mu A$	1.2		2.4	V
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	V _{GE} =4.5 V, I _C = 7A, Tj= 25°C V _{GE} =4.5 V, I _C = 7A, Tj= 125°C		1.2 1.1	1.6	V V

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Table 7: Dynamic

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
9fs	Forward Transconductance	V _{CE} = 15 V, I _C = 7 A		5		S
C _{ies} C _{oes} C _{res}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{CE} = 25V, f = 1 \text{ MHz}, V_{GE} = 0$		800 60 10		pF pF pF
Q _g Q _{ge} Q _{gc}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	V _{CE} = 480V, I _C = 7 A, V _{GE} = 5V (see Figure 20)		16 2.5 8.5	22	nC nC nC
I _{CL}	Turn-Off SOA Minimum Current	V_{clamp} = 480 V , Tj = 125°C R _G = 1 K Ω , V _{GE} =5V	20			Α
tscw	Short Circuit Withstand Time	V_{Ce} = 0.5 $V_{\text{BR(CES)}}$, V_{GE} =5 V , T_{j} = 125°C , R_{G} = 1 $K\Omega$		14		μs

Table 8: Switching On

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Current Rise Time	$\begin{split} &V_{CC} = 480 \text{ V, I}_{C} = 7 \text{ A R}_{G} = 1 \text{K}\Omega \text{ ,} \\ &V_{GE} = 5 \text{ V} \\ &\text{(see Figure 18)} \end{split}$		1.1 0.25		µs µs
(di/dt) _{on} E _{on}	Turn-on Current Slope Turn-on Switching Losses	V_{CC} = 480 V, I_{C} = 7 A R _G =1K Ω V _{GE} = 5 V,Tj = 125°C		45 2.7		A/µs mJ

Table 9: Switching Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _c	Cross-over Time	$V_{CC} = 480 \text{ V}, I_{C} = 7 \text{ A},$		2.7		μs
$t_r(V_{\text{off}})$	Off Voltage Rise Time	$R_{GE} = 1K\Omega$, $V_{GE} = 5 V$ (see Figure 18)		1.6		μs
$t_{d(off)}$	Delay Time	(600) (9010) (9)		5.2		μs
t _f	Current Fall Time			1.1		μs
E _{off} (**)	Turn-off Switching Loss			4.1		mJ
t _C	Cross-over Time	V _{CC} = 480 V, I _C = 7 A,		4.4		μs
$t_r(V_{\text{off}})$	Off Voltage Rise Time	$R_{GE} = 1K\Omega$, $V_{GE} = 5 V$ Ti = 125 °C		2.4		μs
$t_{d(off)}$	Delay Time	(see Figure 18)		6.4		μs
t _f	Fall Time			1.7		μs
E _{off} (**)	Turn-off Switching Loss			7.1		mJ

^(**)Turn-off losses include also the tail of the collector current.

Figure 3: Output Characteristics

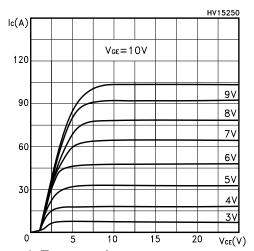


Figure 4: Transconductance

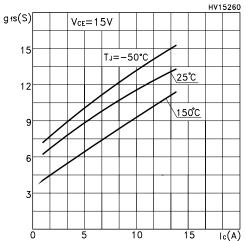


Figure 5: Collector-Emitter On Voltage vs Collector Current

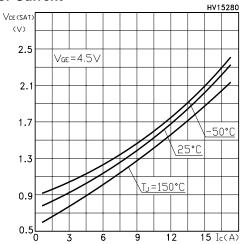


Figure 6: Transfer Characteristics

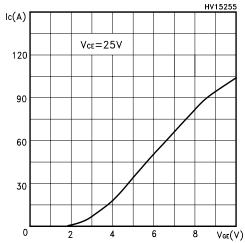


Figure 7: Collector-Emitter On Voltage vs Temperature

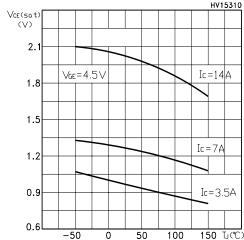
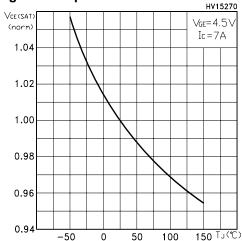


Figure 8: Normalized Collector-Emitter On Voltage vs Temperature



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Figure 9: Gate Thereshold vs Temperature

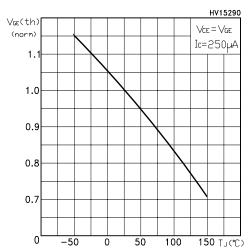


Figure 10: Capacitance Variations

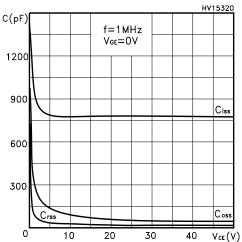


Figure 11: Total Switching Losses vs Gate Resistance

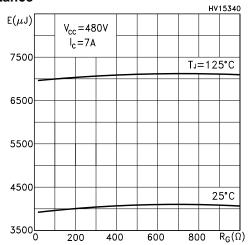


Figure 12: Normalized Breakdown Voltage vs Temperature

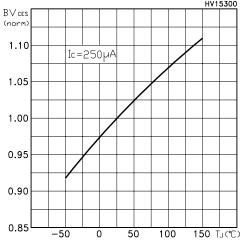


Figure 13: Gate Charge vs Gate-Emitter Voltage

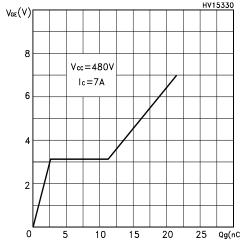


Figure 14: Total Switching Losses vs Temperature

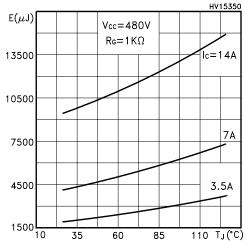


Figure 15: Total Switching Losses vs Collector Current

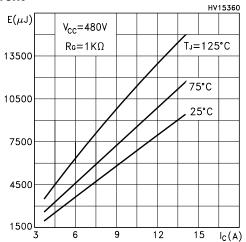


Figure 16: Thermal Impedance

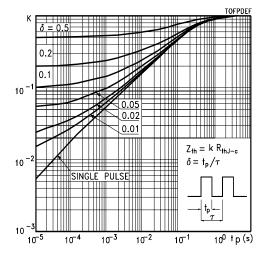
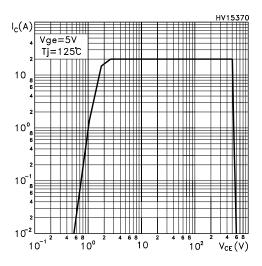


Figure 17: Turn-Off SOA



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Figure 18: Test Circuit for Inductive Load Switching

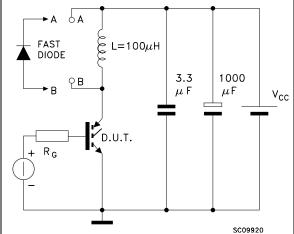


Figure 19: Switching Waveforms

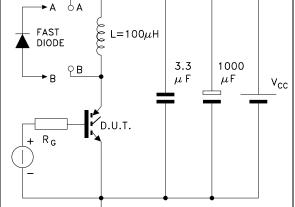


Figure 20: Gate Charge Test Circuit

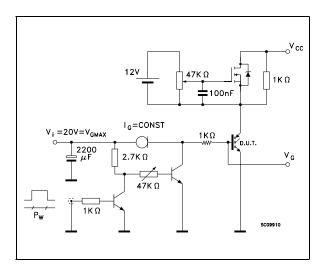




Table 10: Revision History

Date	Revision	Description of Changes
04-June-2004	2	Stylesheet update. No content change
02-Sep-2004	3	Datasheet updated, see table1

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